

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	249	(432/259).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/07 10:25
S2	324	(432/258).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/07 10:39
S3	268	S2 not S1	US-PGPUB; USPAT; USOCR	OR	ON	2007/11/07 10:26
S4	88	(semiconductor wafer substrate) and S3	US-PGPUB; USPAT; USOCR	OR	ON	2007/11/07 11:54
S5	647	(432/253).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/07 10:39
S6	238	(semiconductor wafer substrate) and S5	US-PGPUB; USPAT; USOCR	OR	ON	2007/11/07 10:57
S7	175	S6 not (S4 S1)	US-PGPUB; USPAT; USOCR	OR	ON	2007/11/07 10:57
S8	306	(211/41.18).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/07 11:44
S9	292	(semiconductor wafer substrate) and S8	US-PGPUB; USPAT; USOCR	OR	ON	2007/11/07 11:44
S10	248	S9 not (S7 S4 S1)	US-PGPUB; USPAT; USOCR	OR	ON	2007/11/07 10:58
S11	379	(148/527).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/07 11:44
S12	129	(semiconductor wafer substrate) and S11	US-PGPUB; USPAT; USOCR	OR	ON	2007/11/07 11:45
S13	129	S12 not (S10 S7 S4 S1)	US-PGPUB; USPAT; USOCR	OR	ON	2007/11/07 11:45
S14	517	((432/259) or (432/258)).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/07 11:54
S15	103	(semiconductor wafer substrate) and S14 and support	US-PGPUB; USPAT; USOCR	OR	ON	2007/11/07 11:55